

ZHEN XU

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Education

University of Science and Technology of China

Sep. 2020 – Present

Bachelor of Engineering in Electrical Engineering

Hefei, Anhui

GPA: 3.42/4.3(85/100) Ranking: 25/76

Honors: Scholarship for Elite Class, Awarded to students admitted to the Elite Class

Relevant Coursework

- Design of Analog Integrated Circuits
- Digital Integrated Circuits Design
- The Practice of Chip Design
- Electromagnetic Field and Wave
- Linear Electronic Circuits
- Nonlinear Electronic Circuits
- Digital Logic Circuits
- Materials and physics of semiconductors

Academic Activities

Design and Implementation of Integer Square Root Circuit | Verilog HDL, Cadence

May 2024

- Designed an Integer Square Root circuit and its testbench using Verilog HDL.
- Conducted code simulation and netlist simulation using Cadence Incisive.
- Conducted logic synthesis and equivalence checking using Cadence Genus.
- Completed physical design of the chip using Cadence Innovus.

Design and Application of Operational Amplifier Circuits | Cadence

June 2024

- Used Cadence to design an Open Loop Operational Amplifier that meets the following specifications: a Gain of 90dB, a Unit Gain Bandwidth of approximately 80MHz, a Phase Margin greater than 50°, a Slew Rate greater than 25V/μs, an Output Swing greater than 0.6V, an output DC level of approximately 1V, and a power consumption of less than 1mW.
- Used this Operational Amplifier to design a Voltage Follower, which has a Bandwidth of 90MHz and good tracking characteristics within the range of 450mV to 1.8V (with a supply voltage of 1.8V and an allowable error of 10μV).
- Used this Operational Amplifier to design an Inverting Amplifier with a Gain of -10, featuring excellent low-frequency gain and Bandwidth.

Research Experience

Integrated Nanoelectronics and X-Computing Lab, USTC

March 2023 – August 2023

Research Intern

Hefei, Anhui

- Conducted extensive research on two-dimensional semiconductor devices, focusing particularly on the manufacture and properties of MoS_2 , and enhancing its interface properties using *hexagonal BN*.
- Participated in hands-on production activities for transistor devices, including scribing, lithography, lift-off, ALD, CVD, and more, to assess the properties of 2D semiconductor devices.

Power and Mixed-signal IC Lab, USTC

September 2024 – Present

Research Intern

Hefei, Anhui

- Designed a current-mode Bandgap Reference using the TSMC 180nm process. Chopping and Dynamic Element Matching (DEM) techniques were used to mitigate operational amplifier offset and mismatches in PMOS current mirrors, respectively. Trimming was utilized to reduce PTAT errors. A Low Dropout regulator (LDO) was integrated to enhance the Power Supply Rejection Ratio (PSRR) of the Bandgap circuit, and curvature compensation technology was applied to significantly reduce the Temperature Coefficient (TC).
- The Bandgap Reference achieved an output voltage of 2.5V, with a supply voltage range of 3.3V to 5V. It demonstrated a Power Supply Rejection Ratio (PSRR) of -132dB, a Line Regulation (LR) of 55.6ppm/V, a Temperature Coefficient (TC) of 2.44ppm/°C over -40°C to 125°C, and a startup time of 7.5ms. The variation coefficient σ/μ of the output voltage was 0.52%, with a Current Consumption of 141μA.

Skills

Languages: Chinese(native), English(TOEFL 106, GRE 323+3.5)

Programming Languages: Verilog HDL, C, LaTeX, MATLAB

Developer Tools: Cadence, Quartus, VS Code, MATLAB

Interests

Long-distance Running: Running long distances 4 to 5 times a week has become a habit that helps me stay focus at work.

Frontend Development: I created my [personal homepage](#) and developed a [guide website](#) for studying abroad.